



Application Specific Discretes  
A.S.D.

## ESDA6V1-5P6 TRANSIL™ ARRAY FOR ESD PROTECTION

### MAIN APPLICATIONS

Where transient overvoltage protection in ESD sensitive equipment is required, such as :

- Computers
- Printers
- Communication systems and cellular phones
- Video equipment

This device is particularly adapted to the protection of symmetrical signals.

### FEATURES

- 5 UNIDIRECTIONAL TRANSIL™ FUNCTIONS.
- BREAKDOWN VOLTAGE  $V_{BR} = 6.1V$  MIN
- LOW LEAKAGE CURRENT  $< 500$  nA
- VERY SMALL PCB AREA  $< 2.6$  mm<sup>2</sup>

### DESCRIPTION

The ESDA6V1-5P6 is a monolithic array designed to protect up to 5 lines against ESD transients.

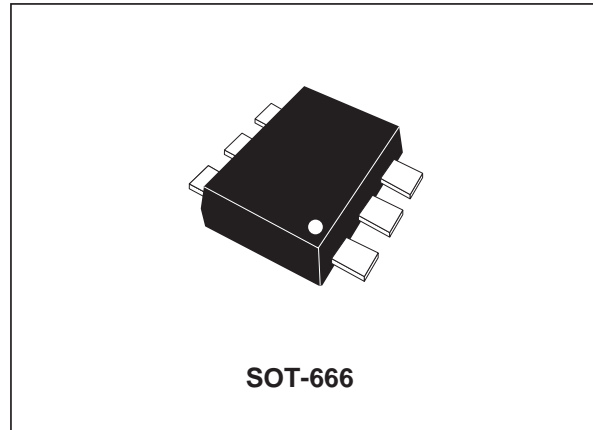
This device is ideal for applications where board space saving is required.

### BENEFITS

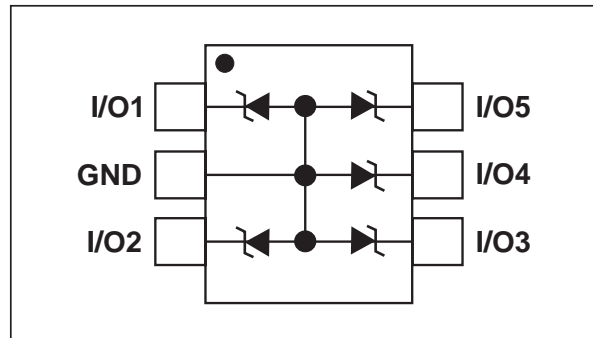
- High ESD protection level.
- High integration.
- Suitable for high density boards.

### COMPLIES WITH THE FOLLOWING STANDARDS :

- IEC61000-4-2 level 4: 15 kV (air discharge)  
8 kV (contact discharge)
- MIL STD 883E-Method 3015-7: class 3  
25kV HBM (Human Body Model)



### FUNCTIONAL DIAGRAM



## ESDA6V1-5P6

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^{\circ}\text{C}$ )

Symbol	Parameter	Test conditions	Value	Unit
$V_{PP}$	ESD discharge - IEC61000-4-2 air discharge IEC61000-4-2 contact discharge		$\pm 15$ $\pm 8$	kV
$P_{PP}$	Peak pulse power (8/20 $\mu\text{s}$ ) (see note 1)	$T_j \text{ initial} = T_{amb}$	150	W
$T_j$	Junction temperature		125	$^{\circ}\text{C}$
$T_{stg}$	Storage temperature range		- 55 to + 150	$^{\circ}\text{C}$
$T_L$	Maximum lead temperature for soldering during 10s at 5mm for case		260	$^{\circ}\text{C}$
$T_{op}$	Operating temperature range		- 40 to + 150	$^{\circ}\text{C}$

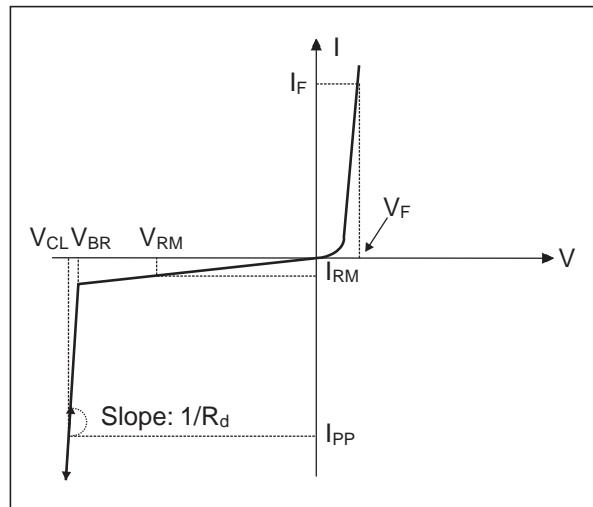
**Note 1:** for a surge greater than the maximum values, the diode will fail in short-circuit.

### THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient on printed circuit on recommended pad layout	220	$^{\circ}\text{C}/\text{W}$

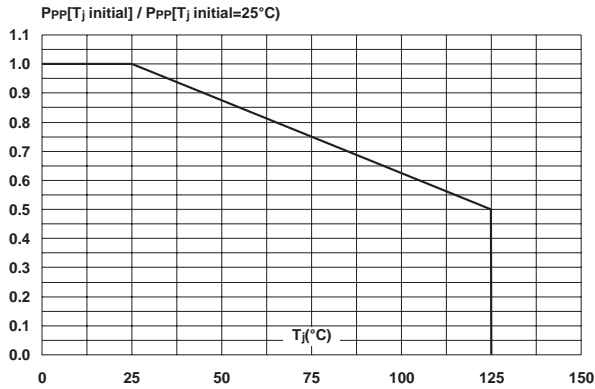
### ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25^{\circ}\text{C}$ )

Symbol	Parameter
$V_{RM}$	Stand-off voltage
$V_{BR}$	Breakdown voltage
$V_{CL}$	Clamping voltage
$I_{RM}$	Leakage current
$I_{PP}$	Peak pulse current
$\alpha T$	Voltage temperature coefficient
$V_F$	Forward voltage drop
$C$	Capacitance per line
$R_d$	Dynamic resistance

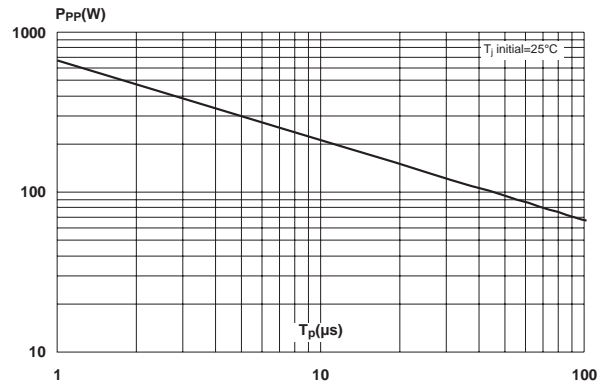


Types	$V_{BR}$ @		$I_R$	$I_{RM}$ @ $V_{RM}$		$R_d$ typ.	$\alpha T$ max.	$C$ typ. @ 0V
	min.	max.		max.				
	V	V	mA	$\mu\text{A}$	V	$\Omega$	$10^{-4}/^{\circ}\text{C}$	pF
ESDA6V1-5P6	6.1	7.2	1	0.5	3	1.5	4.5	70

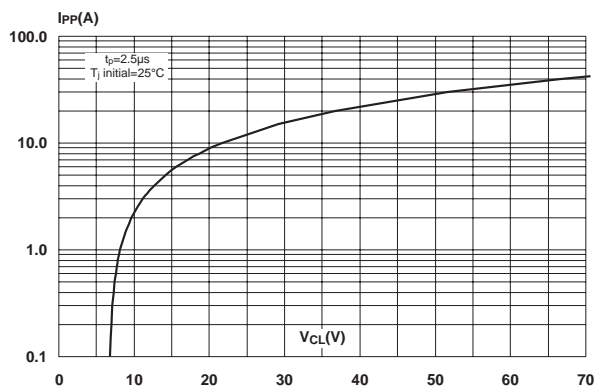
**Fig. 1:** Relative variation of peak pulse power versus initial junction temperature.



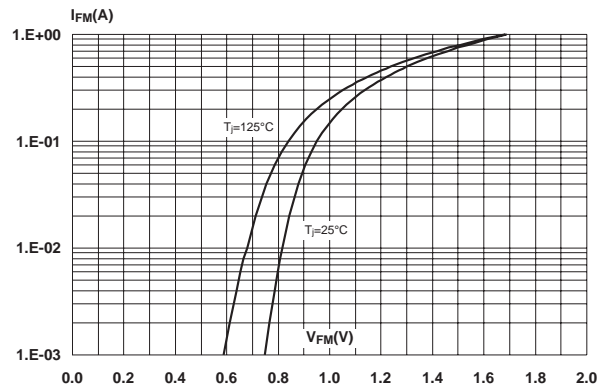
**Fig. 2:** Peak pulse power versus exponential pulse duration.



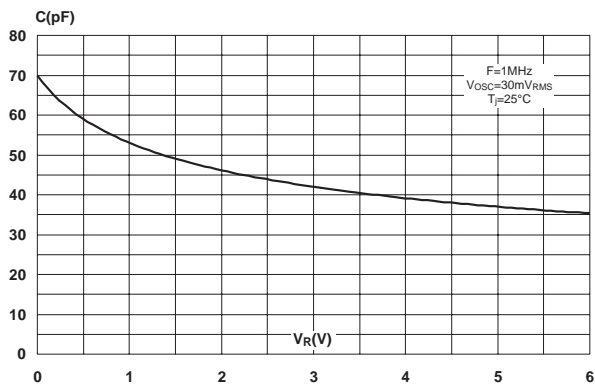
**Fig. 3:** Clamping voltage versus peak pulse current (typical values, rectangular waveform).



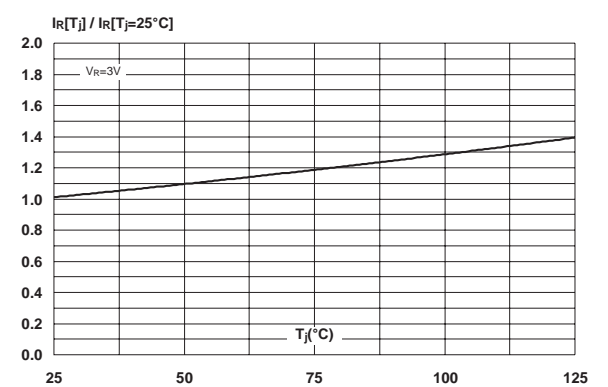
**Fig. 4:** Forward voltage drop versus peak forward current (typical values).



**Fig. 5:** Junction capacitance versus reverse voltage applied (typical values).

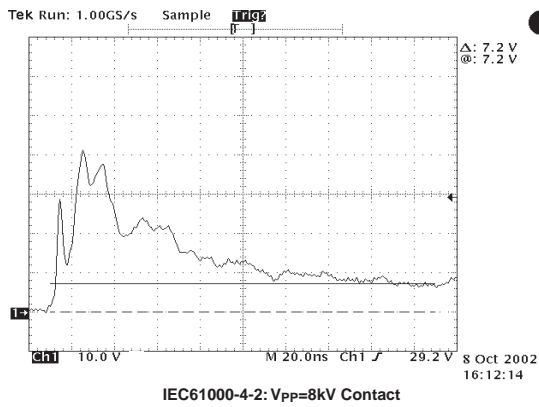


**Fig. 6:** Relative variation of leakage current versus junction temperature (typical values).

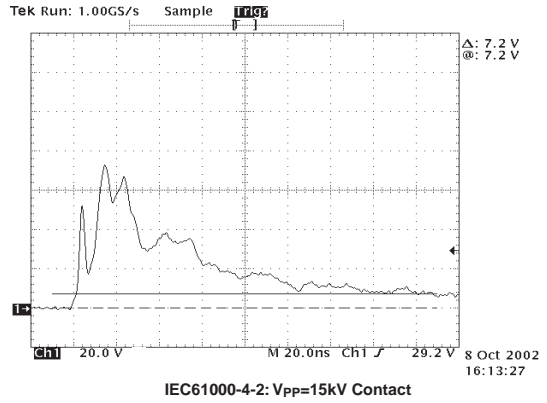


**ESDA6V1-5P6**

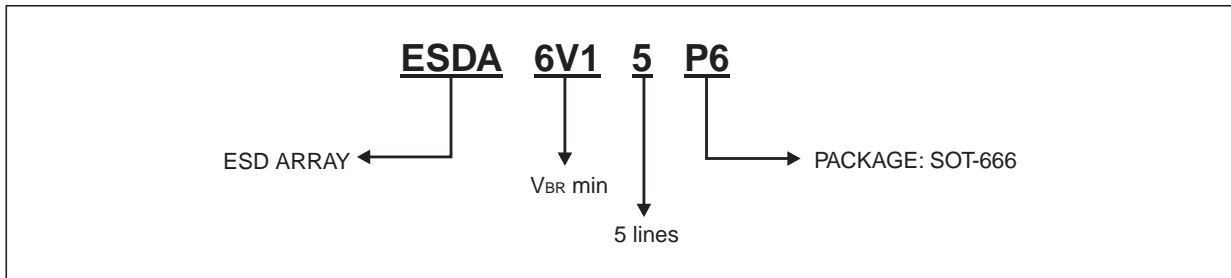
**Fig. 7: ESD response @  $V_{PP}=8kV$  contact.**



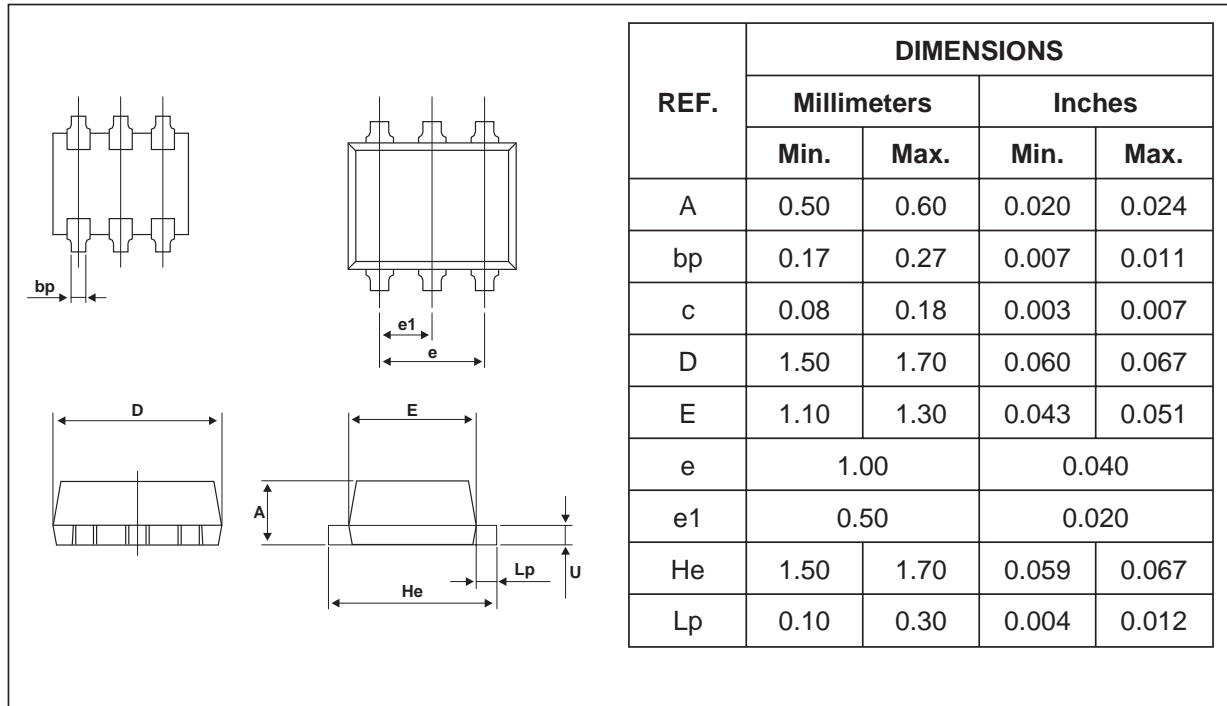
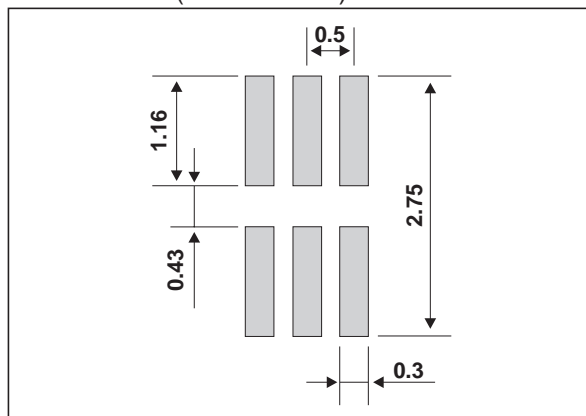
**Fig. 8: ESD response @  $V_{PP}=15kV$  contact.**



**ORDER CODE**



Ordering type	Marking	Package	Weight	Base qty	Delivery mode
ESDA6V1-5P6	C	SOT-666	2.9 mg.	3000	Tape & reel

**PACKAGE MECHANICAL DATA**  
 SOT-666

**FOOT PRINT (in millimeters)**


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